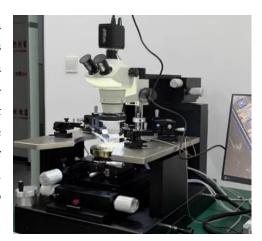


High Frequency Probe Station

Introduction

The high frequency probe station is a highly-precise manual probe platform for wafers and substrates up to 150 mm. It is ideal station for a wide range of applications, such as RF and mm-Wave characterization, device and wafer test, fault analysis, MEMS and optoelectronic tests. The modular design provides a flexible configuration for various of applications. It can be integrated with third part instrumentation, minimizing the setup times and improving measurement performance.



Technical Specification

Standard Wafer Chuck Diameter: 150 mm Chuck Stage Travel Range: 155 mm × 155 mm

DUT Size Supported: Wafers 25 mm to 150 mm or Shards Vacuum Ring Diameter: 22 mm, 42 mm, 66 mm, 88 mm, 110 mm

Surface Planarity: $<\pm 3~\mu m$ Chuck Stage Resolution: 5 μm Z Height Adjustment Range: 10 mm

Chuck Stage Theta Travel Range: 0~360°